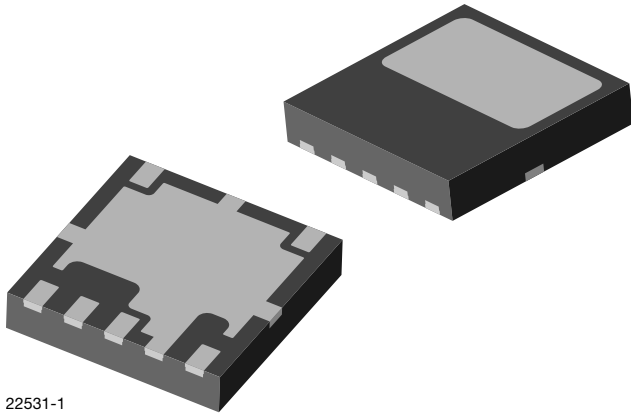


## IR Detector for Mid Range Proximity Sensor



22531-1

### DESIGN SUPPORT TOOLS AVAILABLE


[3D Models](#)

### DESCRIPTION

The TSSP57P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

### ORDERING CODE

#### Taping:

TSSP57P38TT1 - top view taped

TSSP57P38TT2 - top view taped

### FEATURES

- Height of 0.8 mm
- Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- Photo detector and preamplifier in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

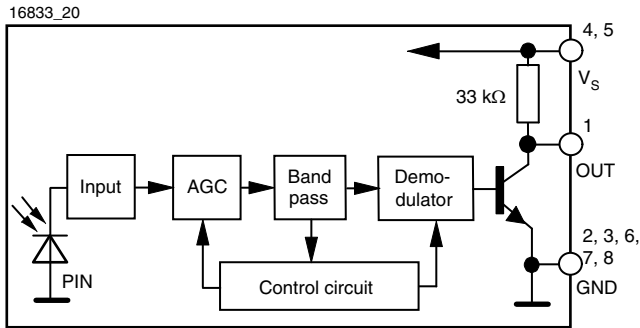
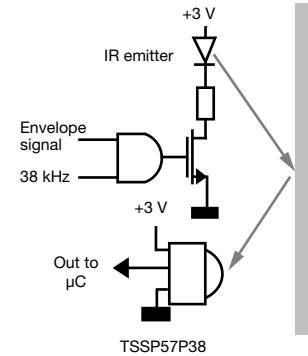


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### APPLICATIONS

- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- Reflective sensors for toilet flush
- Navigational sensor for robotics

PARTS TABLE	
Carrier frequency	38 kHz
Package	TSSP57P38 Belobog
Pinning	1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V <sub>S</sub>
Dimensions (mm)	3.95 W x 3.95 H x 0.8 D
Mounting	SMD
Application	Proximity sensors

**BLOCK DIAGRAM**

**PROXIMITY SENSING**

**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		$V_S$	-0.3 to +6	V
Supply current		$I_S$	5	mA
Output voltage		$V_O$	-0.3 to $(V_S + 0.3)$	V
Output current		$I_O$	5	mA
Junction temperature		$T_j$	100	°C
Storage temperature range		$T_{stg}$	-25 to +85	°C
Operating temperature range		$T_{amb}$	-25 to +85	°C
Power consumption	$T_{amb} \leq 85\text{ °C}$	$P_{tot}$	10	mW

**Note**

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

**ELECTRICAL AND OPTICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ °C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		$V_S$	2.5	-	5.5	V
Supply current	$V_S = 5\text{ V}, E_e = 0$	$I_{SD}$	0.55	0.7	0.9	mA
	$E_v = 40\text{ klx}$ , sunlight	$I_{SH}$	-	0.8	-	mA
Receiving distance	Direct line of sight, IR diode TSAL6200, $I_F = 50\text{ mA}$ , test signal see Fig. 1	$d$	-	18	-	m
Output voltage low	$I_{OSL} = 0.5\text{ mA}, E_e = 0.7\text{ mW/m}^2$ , test signal see Fig. 1	$V_{OSL}$	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$ , test signal see Fig. 1	$E_e\text{ min.}$	-	0.2	0.4	$\text{mW/m}^2$
Maximum irradiance	$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$ , test signal see Fig. 1	$E_e\text{ max.}$	50	-	-	$\text{W/m}^2$
Directivity	Angle of half receiving distance	$\phi_{1/2}$	-	$\pm 75$	-	deg

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

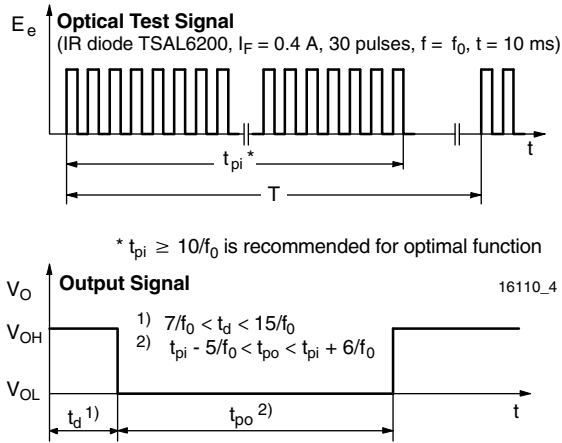


Fig. 1 - Output Active Low

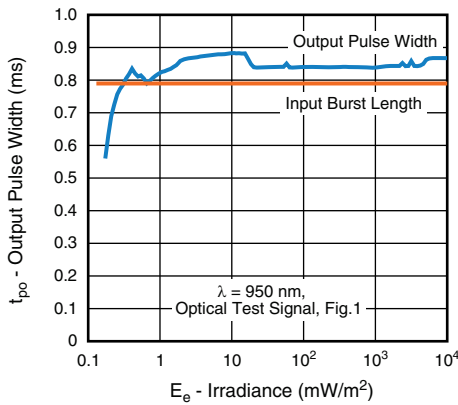


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

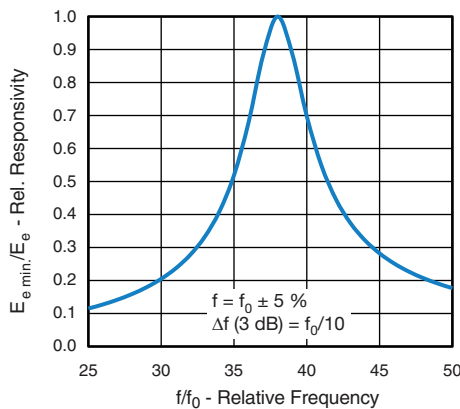


Fig. 3 - Frequency Dependence of Responsivity

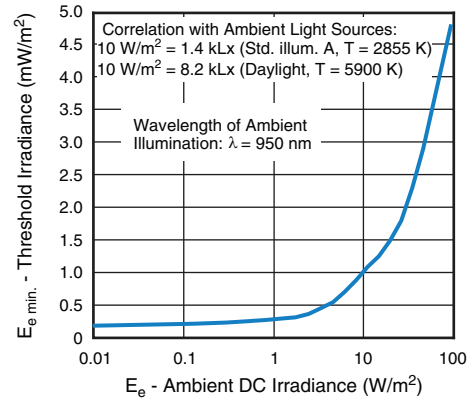


Fig. 4 - Sensitivity in Bright Ambient

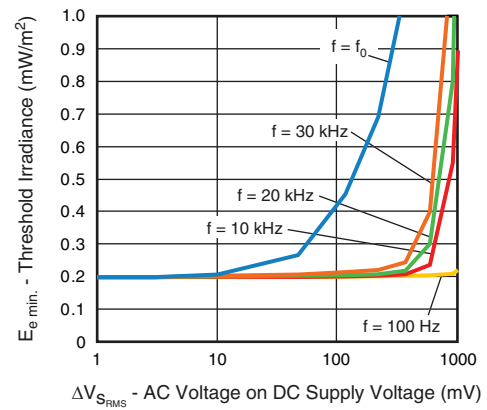


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

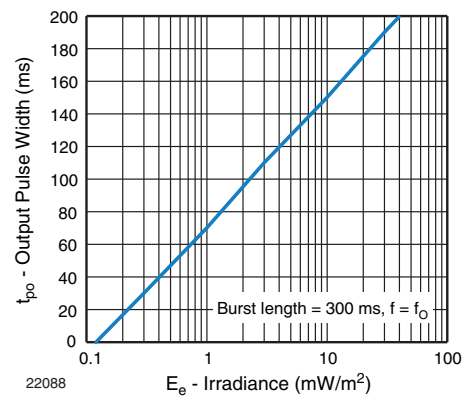


Fig. 6 - Output Pulse Width vs. Irradiance

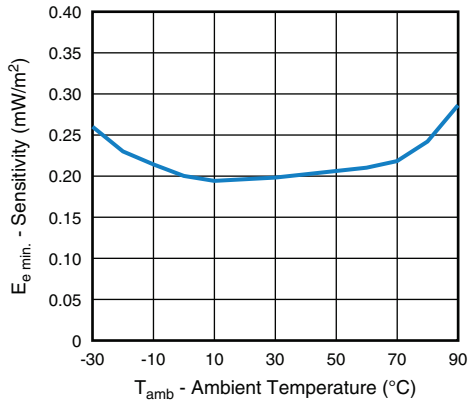


Fig. 7 - Sensitivity vs. Ambient Temperature

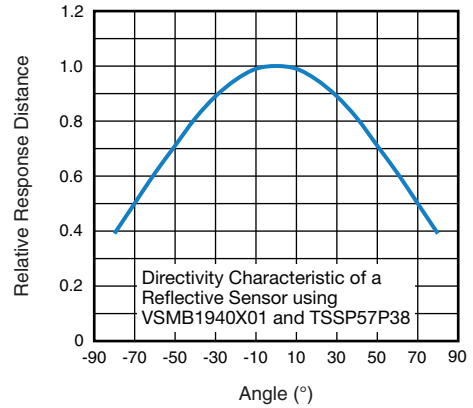


Fig. 10 - Angle Characteristic

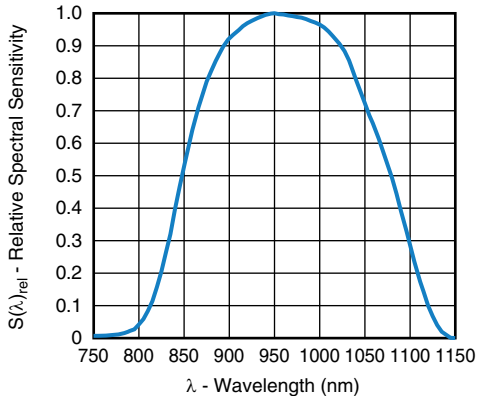


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

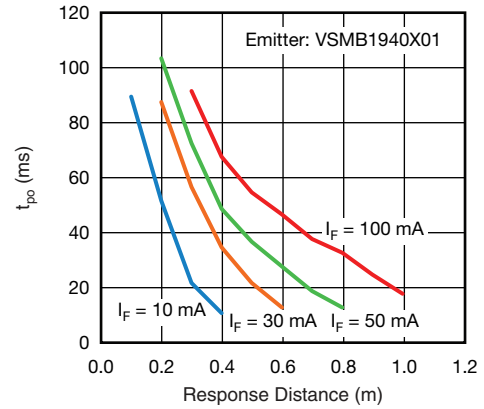


Fig. 11 -  $t_{po}$  vs. Distance

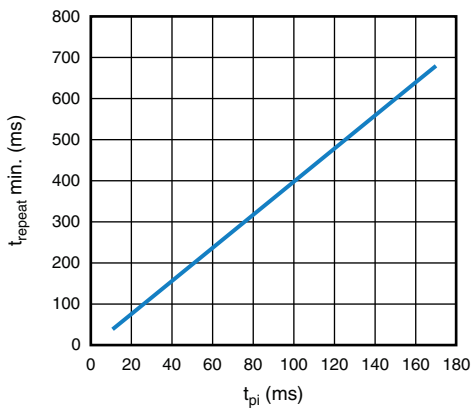


Fig. 9 - Max. Rate of Bursts

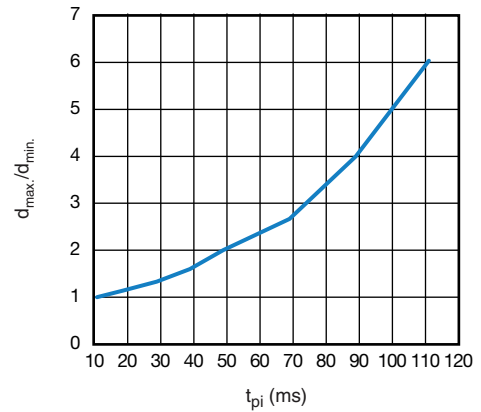
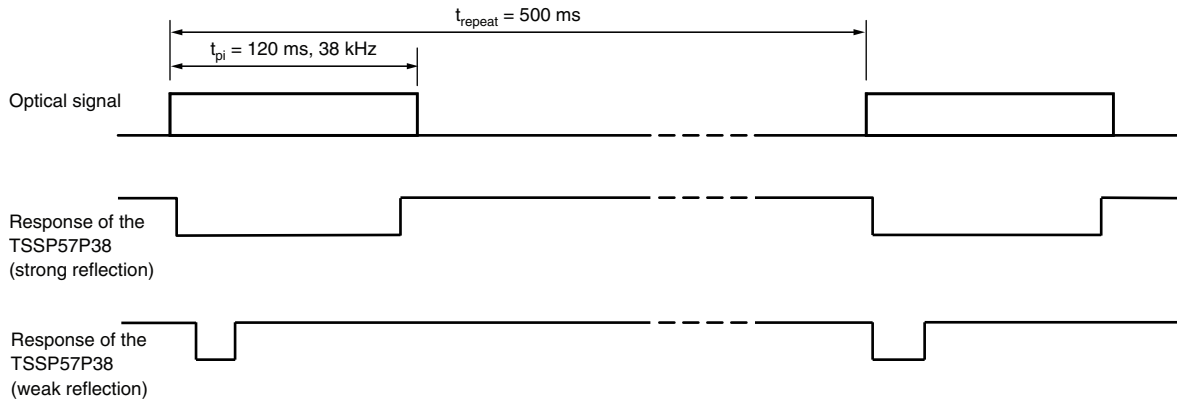


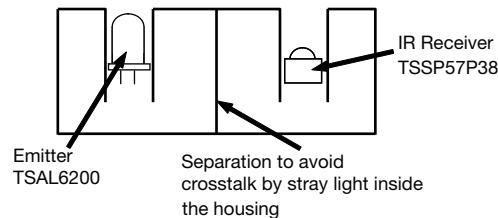
Fig. 12 - Dynamic Range of Sensor vs.  $t_{pi}$

The typical application of the TSSP57P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:



Example for a sensor hardware:

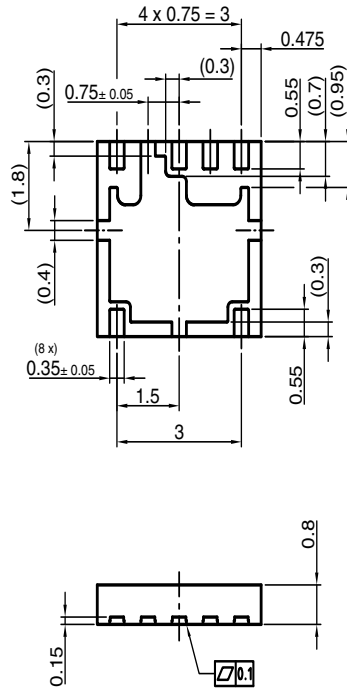


There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP57P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.



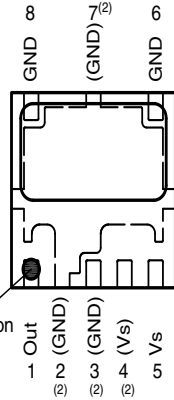
PACKAGE DIMENSIONS in millimeters



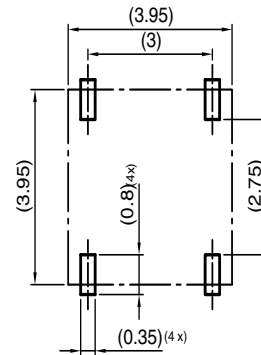
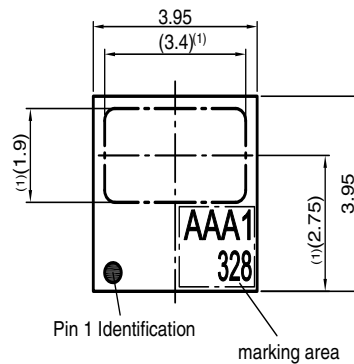
Not indicated tolerances  $\pm 0.1$

  
 technical drawings  
 according to DIN  
 specifications

Pinning from topview



Proposed pad layout from component side (dim. for reference only)



Drawing-No.: 6.550-5315.01-4  
Issue: 2; 12.02.14

Notes

- <sup>(1)</sup> Optically effective area
- <sup>(2)</sup> Pins connected internally. It is not necessary to connect externally



ASSEMBLY INSTRUCTIONS

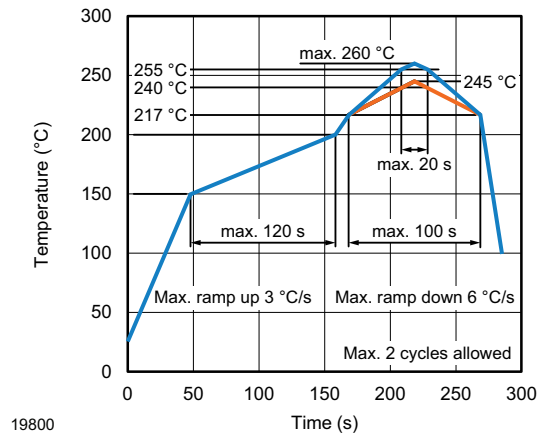
Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



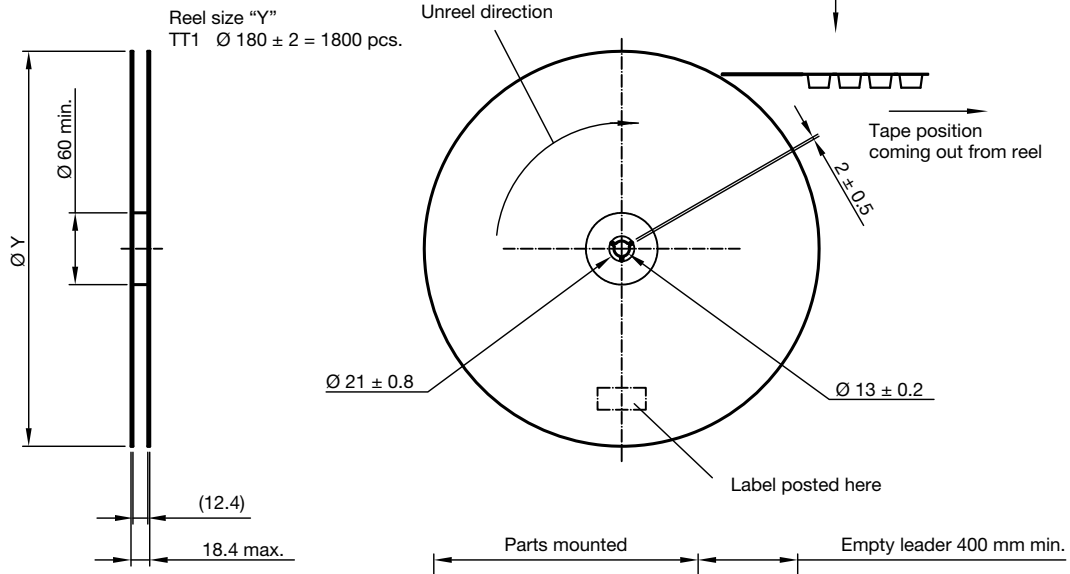
ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME <sup>(1)</sup>	REMARKS
TSSP57P38TT1	Tape and reel	MOQ: 1800 pcs	3.95 mm x 3.95 mm x 0.75 mm
TSSP57P38TT2		MOQ: 7000 pcs	

Note

<sup>(1)</sup> MOQ: minimum order quantity

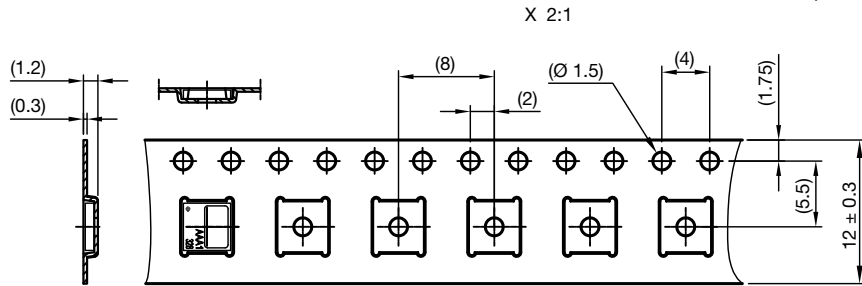
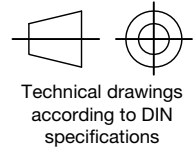
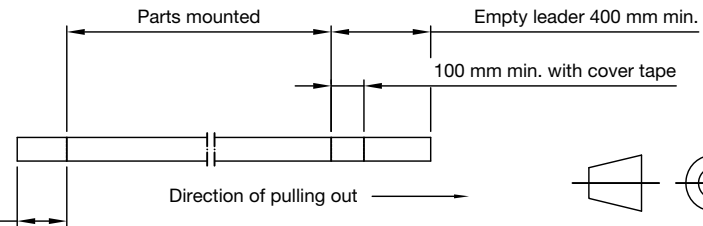
**TAPING VERSION TSSP57P38 DIMENSIONS** in millimeters

Tape and reel dimensions:



Leader and trailer tape:

Empty trailer 200 mm min.



Drawing-No.: 9.700-5347.01-4  
Issue: 2; 07.03.18

Not indicated tolerances ± 0.1



**LABEL**
**Standard bar code labels for finished goods**

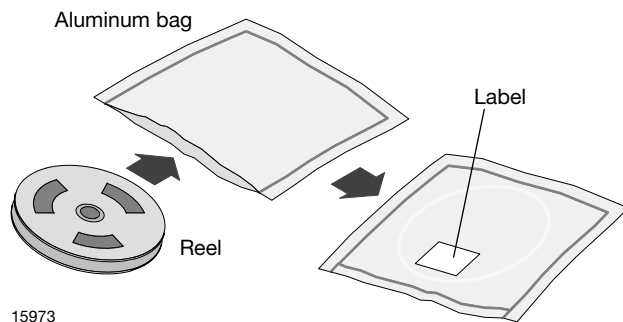
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled

with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

<b>VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)</b>		
<b>PLAIN WRITING</b>	<b>ABBREVIATION</b>	<b>LENGTH</b>
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
<b>Long bar code top</b>	<b>Type</b>	<b>Length</b>
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
<b>Short bar code bottom</b>	<b>Type</b>	<b>Length</b>
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

**DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.


**FINAL PACKING**

The sealed reel is packed into a cardboard box.

**RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 3 label is included on all dry bags.

	<b>Caution</b>	<table border="1"> <tr> <td style="text-align: center;">LEVEL</td> </tr> <tr> <td style="text-align: center; font-size: 2em;">3</td> </tr> </table>	LEVEL	3
	LEVEL			
3				
This bag contains <b>MOISTURE-SENSITIVE DEVICES</b>		If blank, see adjacent bar code label		
1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)				
2. Peak package body temperature: <u>260</u> °C <small>If blank, see adjacent bar code label</small>				
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be				
a) Mounted within: <u>168</u> hours of factory conditions <small>If blank, see adjacent bar code label</small> ≤30°C/60% RH, or				
b) Stored per J-STD-033				
4. Devices require bake, before mounting, if:				
a) Humidity Indicator Card reads > 10% for level 2a - 5a devices or >60% for level 2 devices when read at 23±5°C				
b) 3a or 3b are not met				
5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure				
Bag Seal Date: _____ <small>If blank, see adjacent bar code label</small>				
<small>Note: Level and body temperature defined by IPC/JEDEC J-STD-020</small>				

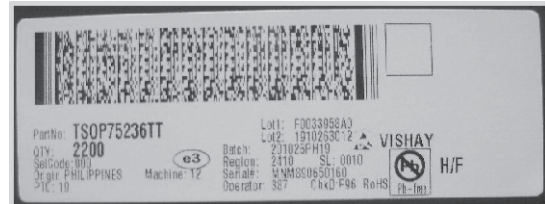
22650

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

**VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

**BAR CODE PRODUCT LABEL (Example)**



22178

**ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.



## **Disclaimer**

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